

High bandwidth analog switch with 16-to-8 bit MUX/DEMUX

Features

- Low R_{ON} : 5.5 Ω typical
- V_{CC} operating range: 3.0 to 3.6 V
- Low current consumption: 20 μA
- ESD HBM model: > 2 kV
- Channel on capacitance: 7.5 pF typical
- Switching time speed: 9 ns
- Near to zero propagation delay: 250 ps
- Very low cross talk: -40 db at 250 MHz
- Bit-to-bit skew: 200 ps
- > 450 MHz -3 db typical bandwidth
- Package: QFN56
- Lead-free



Table 1. Device summary

Order code	Package	Packing
ST3DV520QTR	QFN56	Tape and reel

1 Description

The ST3DV520 is a 16- to 8-bit bidirectional multiplexer/demultiplexer low R_{ON} and high bandwidth switch suitable for analog video applications.

The ST3DV520 supports high definition (HD) analog video switching standards and is also suitable for general purpose switching that requires high signal integrity.

The device is designed for very low crosstalk, low bit-to-bit skew and low I/O capacitance. The signal from each input is multiplexed into one of two selected outputs while the unselected switch goes to HI-Z status.

2 Pin description

Figure 1. Pin connection (top through view)

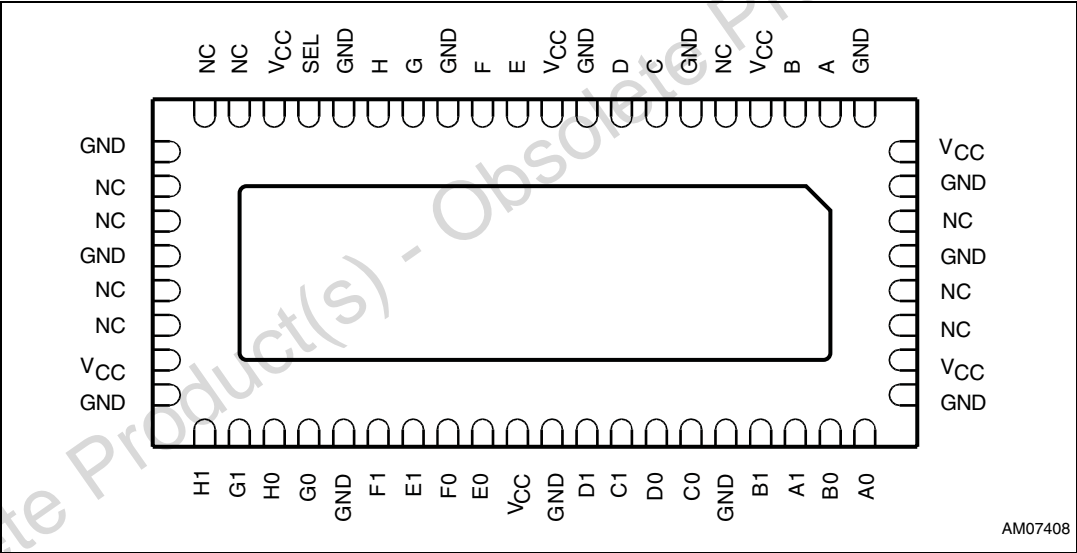


Table 2. Pin description

Pin number	Symbol	Name and function
2, 3, 7, 8, 11, 12, 14, 15	A, B, C, D, E, F, G, H	8-bit bus
31, 32, 36, 37, 42, 43, 47, 48	A0, B0, C0, D0, E0, F0, G0, H0	8-bit multiplexed to bus 0
29, 30, 35, 40, 41, 45, 46	A1, B1, C1, D1, E1, F1, G1, H1	8-bit multiplexed to bus 1
17	SEL	Bus switch selection
5, 19, 20, 22, 23, 25, 26, 51, 52, 54	NC	Not connected
4, 10, 18, 27, 38, 50, 56	V _{CC}	Supply voltage
1, 6, 9, 13, 16, 21, 24, 28, 33, 39, 44, 49, 53, 55	GND	Ground

Figure 2. Input equivalent circuit

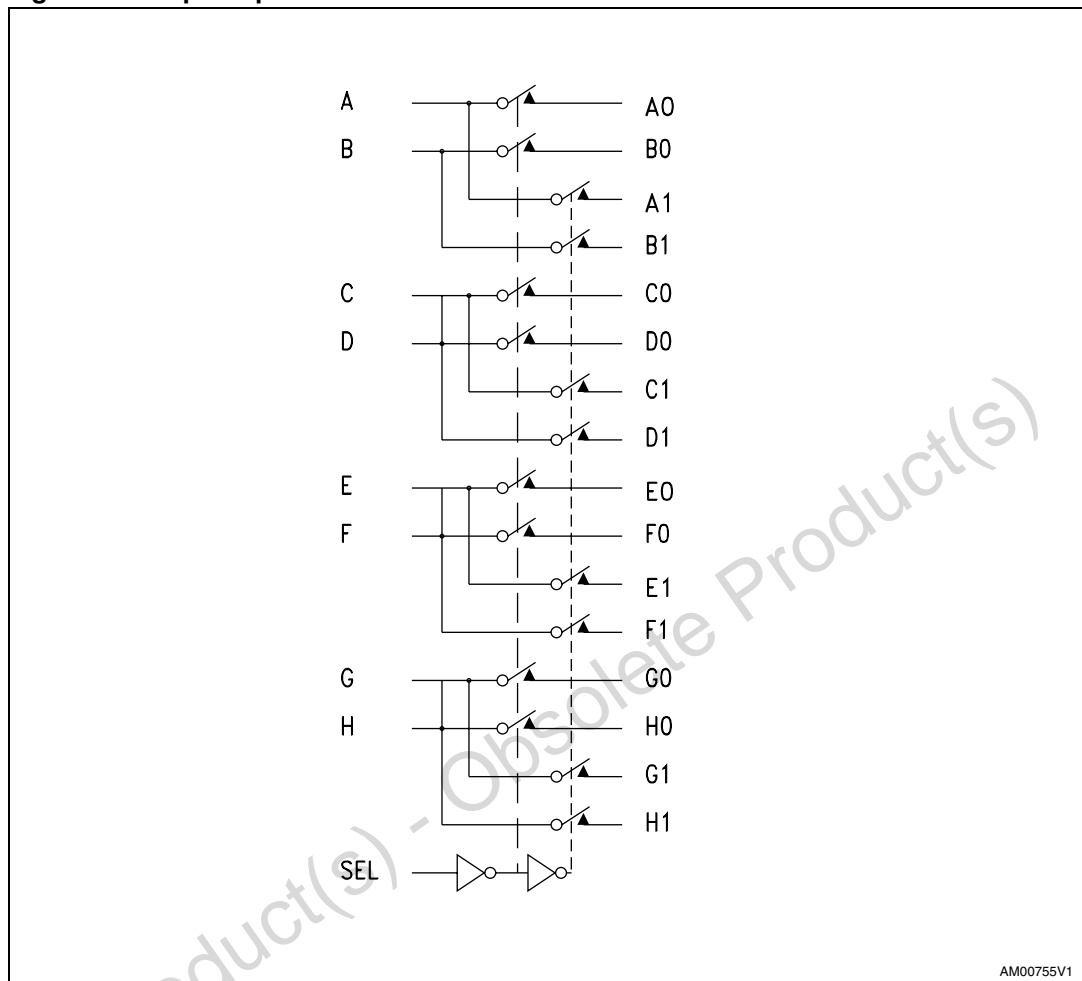


Table 3. Switch function table

SE	Function
L	8-bit bus to 8-bit multiplexed bus 0
H	8-bit bus to 8-bit multiplexed bus 1

3 Maximum ratings

Stressing the device above the rating listed in the “Absolute Maximum Ratings” table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics™ SURE program and other relevant quality documents.

3.1 Absolute maximum ratings

Table 4. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage to ground	-0.5 to 4	V
V_I	DC input voltage	-0.5 to 4	V
V_{IC}	DC control input voltage	-0.5 to 4	V
I_O	DC output current ⁽¹⁾	120	mA
P_D	Power dissipation	0.5	W
T_{stg}	Storage temperature	-65 to 150	°C
T_L	Lead temperature (10 sec)	300	°C

1. If $V_{IO} \times I_O$ does not exceed the maximum limit of P_D .

Table 5. DC electrical characteristics ($T_A = -40$ to $85\text{ }^\circ\text{C}$, $V_{CC} = 3.3\text{ V} \pm 10\%$)

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
V_{IH}	Voltage input high	High level guaranteed	2			V
V_{IL}	Voltage input low	Low level guaranteed	-0.5		0.8	V
V_{IK}	Clamp diode voltage	$V_{CC} = 3.6\text{ V}$, $I_{IN} = -18\text{ mA}$		-0.8	-1.2	V
I_{IH}	Input high current	$V_{CC} = 3.6\text{ V}$, $V_{IN} = V_{CC}$			± 5	μA
I_{IL}	Input low current	$V_{CC} = 3.6\text{ V}$, $V_{IN} = \text{GND}$			± 5	μA
I_{OFF}	Power down leakage current	$V_{CC} = 0\text{ V}$, A to H $V = 0\text{ V}$, A0 to H0 and A1 to H1 $\leq 3.6\text{ V}$			± 5	μA
R_{ON}	Switch ON resistance ⁽¹⁾	$V_{CC} = 3.0\text{ V}$, $V_{IN} = 1.5$ to V_{CC} $I_{IN} = -40\text{ mA}$		5.5	7.5	Ω
R_{FLAT}	ON resistance flatness ⁽¹⁾⁽²⁾	$V_{CC} = 3.0\text{ V}$, V_{IN} at 1.5 and V_{CC} $I_{IN} = -40\text{ mA}$		0.8		Ω
ΔR_{ON}	ON resistance match between channel $\Delta R_{ON} = R_{ONMAX} - R_{ONMIN}$ ⁽¹⁾⁽³⁾	$V_{CC} = 3.0\text{ V}$, $V_{IN} = 1.5$ to V_{CC} $I_{IN} = -40\text{ mA}$		0.5	1	Ω

1. Measured by voltage drop between channels at indicated current through the switch. ON resistance is determined by the lower of the voltage.
2. Flatness is defined as the difference between the R_{ONMAX} and R_{ONMIN} of ON resistance over the specified range.
3. ΔR_{ON} measured at same V_{CC} , temperature and voltage level.

Table 6. Capacitance specifications ($T_A = 25\text{ }^\circ\text{C}$, $f = 1\text{ MHz}$)

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
C_{IN}	Input capacitance ⁽¹⁾	$V_{IN} = 0\text{ V}$		2	3	pF
C_{OFF}	Port x0 to port x1, switch off	$V_{IN} = 0\text{ V}$		4	6	pF
C_{ON}	Capacitance switch on (x to x0 or x to x1)	$V_{IN} = 0\text{ V}$		7.5	11	pF

1. x = A to H, x0 = A0 to H0, x1 = A1 to H1.

Table 7. Power supply characteristics ($T_A = -40$ to $85\text{ }^\circ\text{C}$)

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
I_{CC}	Quiescent power supply	$V_{CC} = 3.6\text{ V}$ $V_{IN} = V_{CC}$ or GND		150	500	μA

Table 8. Dynamic electrical characteristics ($T_A = -40$ to $85\text{ }^\circ\text{C}$, $V_{CC} = 3.3\text{ V} \pm 10\%$)

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
X_{talk}	Crosstalk	$R_L = 100\text{ }\Omega$, $f = 250\text{ MHz}$		-40		dB
O_{IRR}	Off isolation	$R_L = 100\text{ }\Omega$, $f = 250\text{ MHz}$		-36		dB
BW	-3 dB bandwidth	$R_L = 100\text{ }\Omega$		450		MHz

Table 9. Switching characteristics (T_A = -40 to 85 °C, V_{CC} = 3.3 V ± 10%)

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
t _{PD}	Propagation delay	V _{CC} = 3 V to 3.6 V		0.25		ns
t _{PZH} , t _{PZL}	Line enable time, SE to x to x0 or x to x1	V _{CC} = 3 V to 3.6 V	0.5	6.5	9	ns
t _{PHZ} , t _{PLZ}	Line disable time, SE to x to x0 or x to x1	V _{CC} = 3 V to 3.6 V	0.5	6.5	8.5	ns
t _{SK(O)}	Output skew between center port to any other port	V _{CC} = 3 V to 3.6 V		0.1	0.2	ns
t _{SK(P)}	Skew between opposite transition of the same output (t _{PHL} , t _{PLH})	V _{CC} = 3 V to 3.6 V		0.1	0.2	ns

Figure 3. Bandwidth

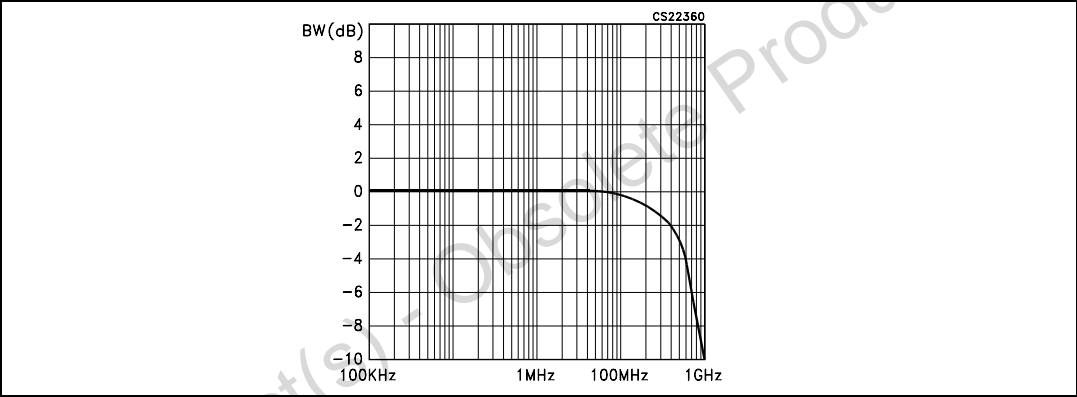
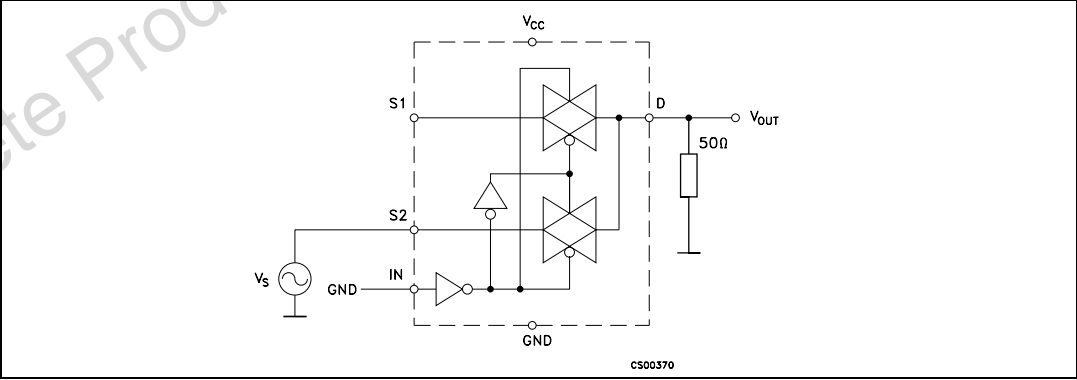


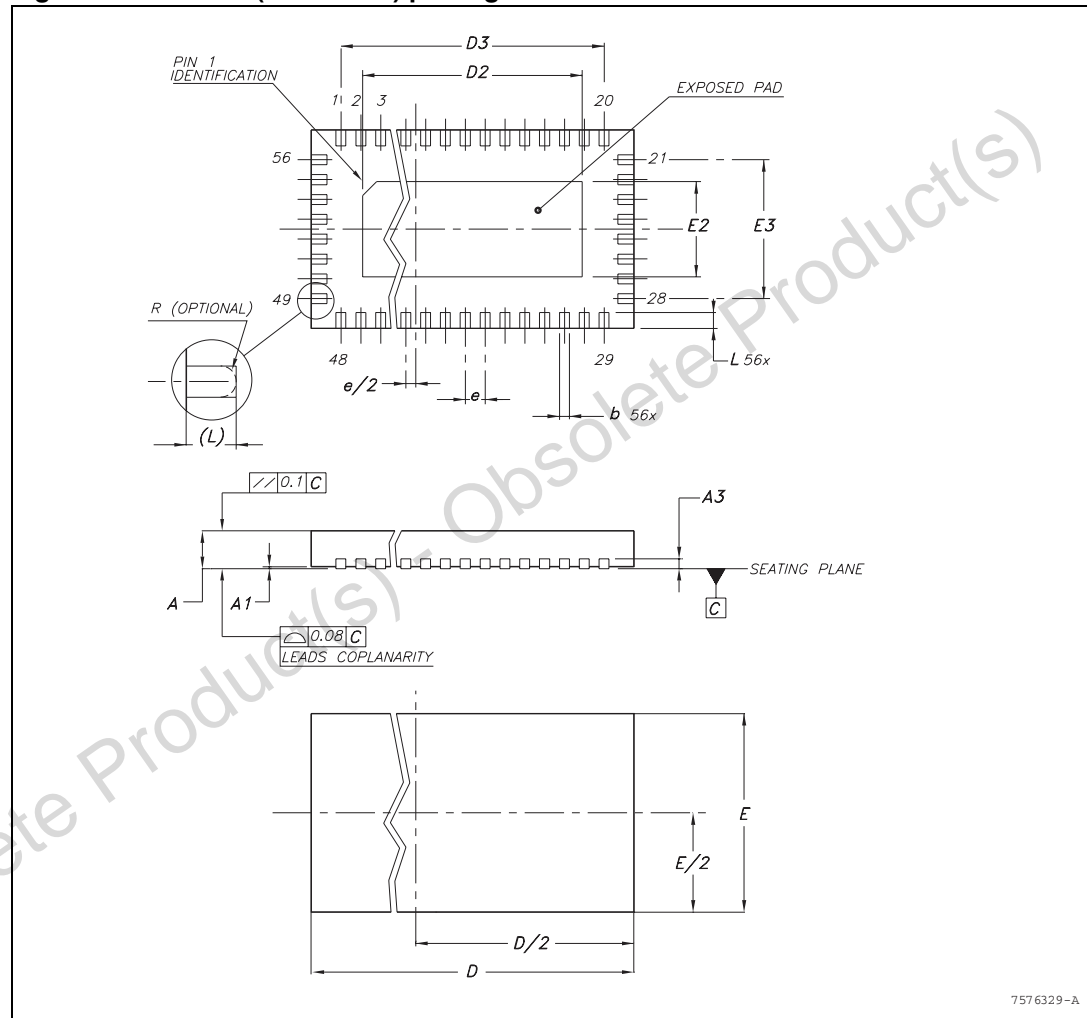
Figure 4. Schematic bandwidth



4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Figure 5. QFN56 (11 x 5 mm) package outline



Symbol	millimeters			inches		
	Min	Typ	Max	Min	Typ	Max
A	0.70	0.75	0.80	0.028	0.030	0.031
A1			0.05			0.002
A3		0.20			0.008	
b	0.20	0.25	0.30	0.008	0.010	0.012
D	10.90	11.00	11.10	0.429	0.433	0.437
D2	8.30	8.40	8.50	0.327	0.331	0.335
D3		9.50			0.374	
E	4.90	5.00	5.10	0.193	0.197	0.201
E2	2.30	2.40	2.50	0.091	0.094	0.098
E3		3.50			0.138	
e		0.50			0.020	
L	0.30	0.40	0.50	0.012	0.016	0.020

5 Revision history

Table 11. Document revision history

Date	Revision	Changes
12-Jun-2007	1	Initial release.
9-Oct-2008	2	Modified: title and pinout configuration. Added: Figure 6: Footprint recommendation on page 8 .
30-Nov-2010	3	Removed status "Preliminary Data", document reformatted, replaced V_{DD} by V_{CC} in Figure 1 , Table 2 , updated text ECOPACK® in Section 4 , corrected typo in Features , Description , Table 2 , Table 3 , Table 5 to Table 9 , removed note below Table 9 .

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